Product data sheet



1. General description

The HEF4541B is a programmable timer which consists of a 16-stage binary counter, an integrated oscillator to be used with external timing components, an automatic power-on reset and output control logic. The frequency of the oscillator is determined by the external components R_{TC} and C_{TC} within the frequency range 1 Hz to 100 kHz. This oscillator may be replaced by an external clock signal at input RS, the timer advances on the positive-going transition of RS. A LOW on the auto reset input (AR) and a LOW on the master reset input (MR) enables the internal power-on reset. A HIGH level at input MR resets the counter independent on all other inputs. Resetting disables the oscillator to provide no active power dissipation.

A HIGH at input AR turns off the power-on reset to provide a low quiescent power dissipation of the timer. The 16-stage counter divides the oscillator frequency by 2^8 , 2^{10} , 2^{13} or 2^{16} depending on the state of the address inputs (A0, A1). The divided oscillator frequency is available at output O. The phase input (PH) features a complementary output signal. When the mode select input (MODE) is LOW the timer is a single transition timer and when HIGH the timer is a 2^n frequency divider.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD} , V_{SS} , or another input.

2. Features and benefits

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Operates across the automotive temperature range –40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1.Ordering information

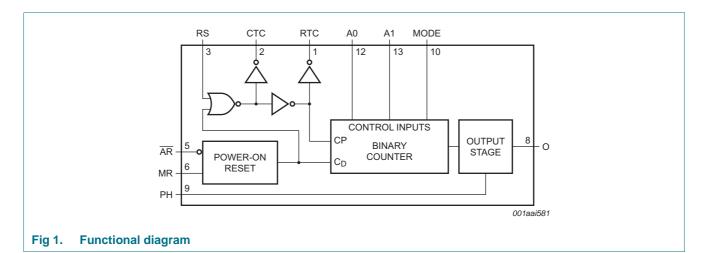
All types operate from -40 °C to +85 °C.

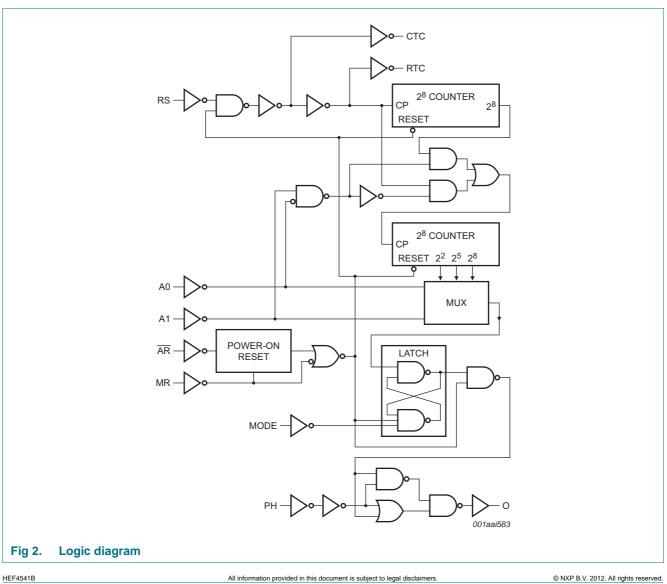
Type number	Package						
	Name	Description	Version				
HEF4541BP	DIP14	plastic dual in-line package; 14 leads (300 mil)	SOT27-1				
HEF4541BT	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1				



Programmable timer

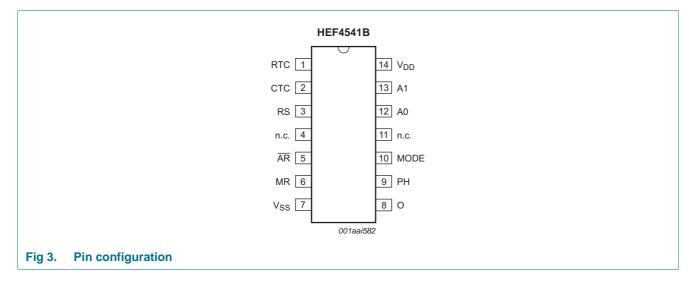
4. Functional diagram





5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
RTC	1	external resistor connection
CTC	2	external capacitor connection
RS	3	external resistor connection (RS) or external clock input
nc	4, 11	not connected
AR	5	auto reset input (active low)
MR	6	master reset input
V _{SS}	7	ground (0 V)
0	8	timer output
PH	9	phase input
MODE	10	mode select input
A0, A1	12, 13	address inputs
V_{DD}	14	supply voltage

6. Functional description

Table 3.Function table^[1]

Input			MODE	
AR	MR	PH	MODE	
Н	L	x	Х	auto reset disabled
L	L	Х	Х	auto reset enabled ^[2]
Х	Н	Х	Х	master reset active
Х	L	Х	Н	normal operation selected division to output
Х	L	Х	L	single-cycle mode ^[3]
Х	L	L	Х	output initially LOW after reset
Х	L	Н	Х	output initially HIGH, after reset

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

[2] For correct power-on reset, the supply voltage should be above 8.5 V. For V_{DD} < 8.5 V, disable the autoreset and connect \overline{AR} to V_{DD} .

[3] The timer is initialized on a reset pulse and the output changes state after 2ⁿ⁻¹ counts and remains in that state (latched). Reset of this latch is obtained by master reset or by a LOW to HIGH transition on the MODE input.

Table 4. Frequency selection table

A0	A1	Number of counter stages n	$\frac{f_{OSC}}{f_O} = 2^n$
L	L	13	8192
L	Н	10	1024
Н	L	8	256
Н	Н	16	65536

7. Limiting values

Table 5.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_{l} < -0.5$ V or $V_{l} > V_{DD}$ + 0.5 V	-	±10	mA
VI	input voltage		-0.5	V _{DD} + 0.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V	-	±10	mA
I _{I/O}	input/output current	O output	-	±10	mA
T _{stg}	storage temperature		-65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$			
		DIP14 package	<u>[1]</u> -	750	mW
		SO14 package	[2] _	500	mW
Р	power dissipation		-	100	mW

[1] For DIP14 package: P_{tot} derates linearly with 12 mW/K above 70 $^\circ C.$

[2] For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

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8. Recommended operating conditions

Recommended operating condition	S			
Parameter	Conditions	Min	Max	Unit
supply voltage		3	15	V
input voltage		0	V_{DD}	V
ambient temperature	in free air	-40	+85	°C
input transition rise and fall rate	$V_{DD} = 5 V$	-	3.75	μs/V
	V _{DD} = 10 V	-	0.5	μs/V
	V _{DD} = 15 V	-	0.08	μs/V
	Parameter supply voltage input voltage ambient temperature	supply voltageinput voltageambient temperatureinput transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$	ParameterConditionsMinsupply voltage3input voltage0ambient temperaturein free air-40input transition rise and fall rate $V_{DD} = 5 V$ - $V_{DD} = 10 V$ -	ParameterConditionsMinMaxsupply voltage315input voltage0 V_{DD} ambient temperaturein free air-40+85input transition rise and fall rate $V_{DD} = 5 V$ -3.75 $V_{DD} = 10 V$ -0.5

9. Static characteristics

Table 7. Static characteristics

 $V_{SS} = 0$ V; $V_I = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	–40 °C	40 °C T _{amb} = 25 °C			T _{amb} = 85 °C		
				Min	Max	Min	Max	Min	Max		
V _{IH} HIGH-level	I _O < 1 μΑ	5 V	3.5	-	3.5	-	3.5	-	V		
	input voltage		10 V	7.0	-	7.0	-	7.0	-	V	
			15 V	11.0	-	11.0	-	11.0	-	V	
V _{IL}	LOW-level	I _O < 1 μA	5 V	-	1.5	-	1.5	-	1.5	V	
	input voltage		10 V	-	3.0	-	3.0	-	3.0	V	
		15 V	-	4.0	-	4.0	-	4.0	V		
V _{OH}	HIGH-level	I _O < 1 μA	5 V	4.95	-	4.95	-	4.95	-	V	
	output voltage	output voltage		10 V	9.95	-	9.95	-	9.95	-	V
		15 V	14.95	-	14.95	-	14.95	-	V		
V _{OL}	LOW-level	I _O < 1 μA	5 V	-	0.05	-	0.05	-	0.05	V	
	output voltage		10 V	-	0.05	-	0.05	-	0.05	V	
			15 V	-	0.05	-	0.05	-	0.05	V	
I _{OH}	HIGH-level	CTC, RTC;									
	output current	$V_{O} = 2.5 V$	5 V	-	-1.4	-	-1.2	-	-0.95	mA	
		$V_0 = 4.6 V$	5 V	-	-0.5	-	-0.4	-	-0.3	mA	
		$V_{0} = 9.5 V$	10 V	-	-1.4	-	-1.2	-	-0.95	mA	
		V _O = 13.5 V	15 V	-	-4.8	-	-4.0	-	-3.2	mA	
		O;									
		$V_0 = 2.5 V$	5 V	-	-1.7	-	-1.4	-	-1.1	mA	
		$V_{0} = 4.6 V$	5 V	-	-0.64	-	-0.5	-	-0.36	mA	
		$V_{0} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	mΑ	
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	mA	

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Symbol	Parameter	Conditions	V _{DD}	T _{amb} =	−40 °C	T _{amb} =	= 25 °C	T _{amb} =	= 85 °C	Unit
				Min	Max	Min	Max	Min	Max	
l _{OL}	LOW-level	CTC, RTC;		1						
output current	$V_{O} = 0.4 V$	5 V	0.33	-	0.27	-	0.20	-	mA	
	$V_{O} = 0.5 V$	10 V	1.0	-	0.85	-	0.68	-	mA	
	V _O = 1.5 V	15 V	3.2	-	2.7	-	2.3	-	mA	
		О;								
		$V_{0} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	mA
		$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.2	-	2.4	-	mA
l _l	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	μA
I _{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	μA
			10 V	-	10	-	10	-	300	μA
			15 V	-	20	-	20	-	600	μA
CI	input capacitance)	-	-	-	-	7.5	-	-	рF

Table 7.Static characteristics ...continued $V_{SS} = 0$ V; $V_l = V_{SS}$ or V_{DD} ; unless otherwise specified.

 Table 8.
 Reset characteristics

 $V_{SS} = 0 V$; $V_I = V_{SS}$ or V_{DD} ; see <u>Table 12</u> for test conditions; unless otherwise specified.

Symbol	Parameter	Conditions	V _{DD}	•	T _{amb} =	–40 °C	Tam	_{ib} = +25	°C	T _{amb} =	+85 °C	Unit
					Min	Max	Min	Тур	Мах	Min	Max	
power-or <u>en</u> able; AR = MR	supply current for	5 V		-	80	-	20	80	-	230	μΑ	
	power-on reset	10 V		-	750	-	250	600	-	700	μΑ	
	$\frac{\text{enable}}{\text{AR}} = \text{MR} = 0 \text{ V}; \text{ Other}$ inputs at 0 V or V _{DD}	15 V		-	1.6	-	0.5	1.3	-	1.5	mA	
V _{DD}	supply voltage	supply voltage for automatic reset initialization; $\overline{AR} = MR = 0$ V; Other inputs at 0 V or V _{DD}	-		-	-	8.5	5	-	-	-	V

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10. Dynamic characteristics

Table 9. Dynamic characteristics

 $V_{SS} = 0$ V; $T_{amb} = 25$ °C unless otherwise specified. For test circuit, see Figure 5.

Symbol	Parameter	Conditions	V_{DD}		Extrapolation formula	Min	Typ <mark>[1]</mark>	Max	Unit
t _{pd}	propagation delay	RS to O;	5 V	[2]	348 ns + (0.55 ns/pF)C _L	-	375	750	ns
		2 ⁸ selected; see Figure 4	10 V		139 ns + (0.23 ns/pF)C _L	-	150	300	ns
		See <u>rigule 4</u>	15 V		102 ns + (0.16 ns/pF)C _L	-	110	220	ns
		RS to O;	5 V		398 ns + (0.55 ns/pF)C _L	-	425	850	ns
		2 ¹⁰ selected; see Figure 4	10 V		154 ns + (0.23 ns/pF)C _L	-	165	330	ns
		See <u>rigule 4</u>	15 V		112 ns + (0.16 ns/pF)C _L	-	120	240	ns
		RS to O;	5 V		483 ns + (0.55 ns/pF)C _L	-	510	1020	ns
		2 ¹³ selected; see Figure 4	10 V		179 ns + (0.23 ns/pF)C _L	-	190	380	ns
		See <u>rigare 4</u>	15 V		127 ns + (0.16 ns/pF)C _L	-	135	270	ns
		2 ¹⁶ selected; 10 V 199 ns + (0.2 see Figure 4	5 V		548 ns + (0.55 ns/pF)C _L	-	575	1150	ns
			10 V		199 ns + (0.23 ns/pF)C _L	-	210	420	ns
			142 ns + (0.16 ns/pF)C _L	-	150	300	ns		
t _W	pulse width	RS LOW; MR HIGH;	5 V	[3]		60	30	-	ns
			10 V			30	15	-	ns
		see <u>Figure 4</u>	15 V			24	12	-	ns
f _{clk(max)}	maximum clock	RS; see Figure 4	5 V			8	16	-	MHz
	frequency		10 V			15	30	-	MHz
			15 V			18	36	-	MHz
f _{osc}	oscillator frequency	$R_t = 5 k\Omega;$	5 V			-	90	-	kHz
		C _t = 1 nF; R _S = 10 kΩ;	10 V			-	90	-	kHz
		$R_S = 10 R_{S2}$, see <u>Figure 6</u>	15 V			-	90	-	kHz
		$R_t = 56 \text{ k}\Omega;$	5 V			-	8	-	kHz
		C _t = 1 nF; R _S = 120 kΩ;	10 V			-	8	-	kHz
		$R_S = 120 R_{S2}$, see Figure 6	15 V			-	8	-	kHz

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

[2] t_{pd} is the same as t_{PHL} and t_{PLH} .

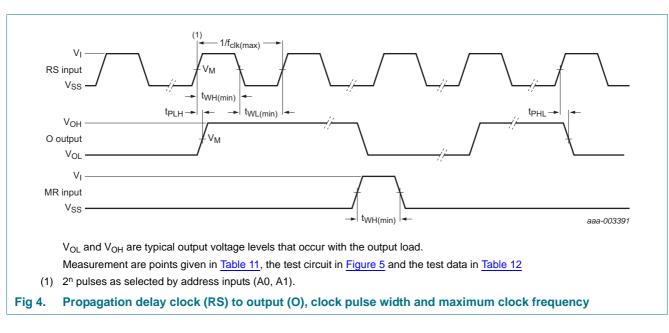
 $\label{eq:WL(min)} [3] \quad t_W \text{ is the same as } t_{WL(min)} \text{ and } t_{WH(min)}.$

Table 10. Dynamic power dissipation

 P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	V_{DD}	Typical formula
Per packag	e		
PD	dynamic power dissipation	$5 \text{ V} \qquad P_{\text{D}} = 1300 \times f_{\text{i}} + (f_{\text{o}} \times C_{\text{L}} \times V_{\text{DD}}^2) \mu\text{W}$	
		10 V	$P_D = 5300 \times f_i + (f_o \times C_L \times V_DD^2) \; \muW$
		15 V	$P_D = 12000 \times f_i + (f_o \times C_L \times V_DD^2) \ \muW$
Using the o	on-chip oscillator		
P _{D(Tot)}	Total dynamic power dissipation	5 V	$P_D = 1300 \times f_osc + f_oC_LV_DD^2 + 2C_TCV_DD^2f_osc + 10V_DD\muW$
		10 V	$P_{D} = 5300 \times f_{osc} + f_{o}C_{L}V_{DD}^{2} + 2C_{TC}V_{DD}^{2} f_{osc} + 100V_{DD} \mu W$
		15 V	$P_{D} = 12000 \times f_{osc} + f_{o}C_{L}V_{DD}^{2} + 2C_{TC}V_{DD}^{2}f_{osc} + 400V_{DD} \mu\text{W}$

[1] $f_i = \text{input frequency in MHz}; f_o = \text{output frequency in MHz}; C_L = \text{output load capacitance in pF}; V_{DD} = \text{supply voltage in V}; f_{osc} = \text{oscillator frequency in MHz}; C_{TC} = \text{timing capacitance in pF}.$



11. Waveforms

Table 11.	Measurement points
-----------	--------------------

Supply voltage	Input	Output
V _{DD}	V _M	V _M
5 V to 15 V	0.5V _{DD}	0.5V _{DD}

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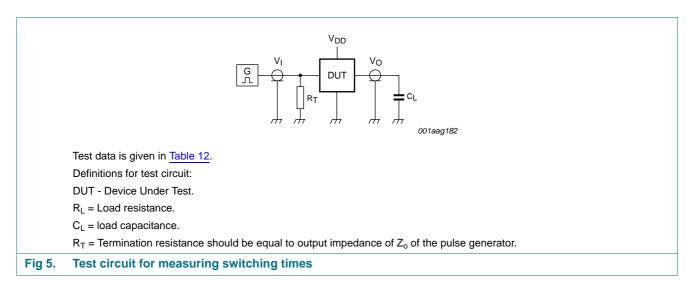


Table 12. Test data

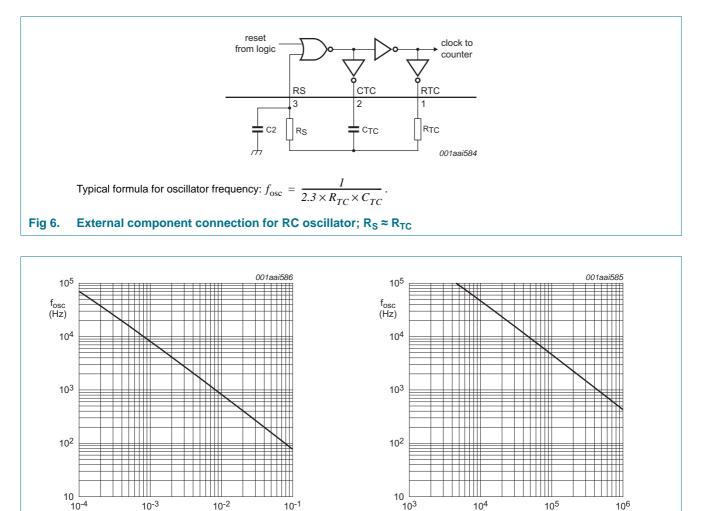
Supply	Input		Load
V _{DD}	VI	t _r , t _f	CL
5 V to 15 V	V _{SS} or V _{DD}	≤ 20 ns	50 pF

12. Application information

RC oscillator timing component limitations

The oscillator frequency is mainly determined by R_{TC}C_{TC}, provided R_{TC} << R_S and R_SC₂ << R_{TC}C_{TC}. The function of R_S is to minimize the influence of the forward voltage across the input protection diodes on the frequency. The stray capacitance C₂ should be kept as small as possible. In consideration of accuracy, C_{TC} must be larger than the inherent stray capacitance. R_{TC} must be larger than the LOCMOS 'ON' resistance in series with it, which typically is 500 Ω at V_{DD} = 5 V, 300 Ω at V_{DD} = 10 V and 200 Ω at $V_{DD} = 15 V.$

The recommended values for these components to maintain agreement with the typical oscillation formula are: $C_{TC} \ge 100 \text{ pF}$, up to any typical value, $10 \text{ k}\Omega \le R_{TC} \le 1 \text{ M}\Omega$.



C_{TC} (µF) R_{TC} (Ω) b. R_{TC} curve at C_{TC} = 1 nF; RS = 2 R_{TC} . a. C_{TC} curve at $R_{TC} = 56 \text{ k}\Omega$; RS = 120 k Ω . RC oscillator frequency as a function of R_{TC} and C_{TC} at V_{DD} = 5 to 15 V; T_{amb} = 25 °C Fig 7.

10-

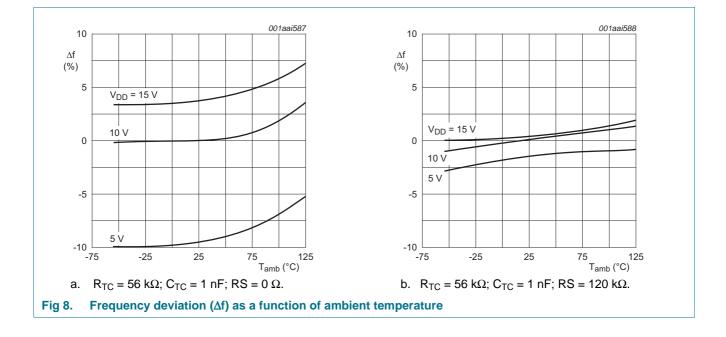
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13. Package outline

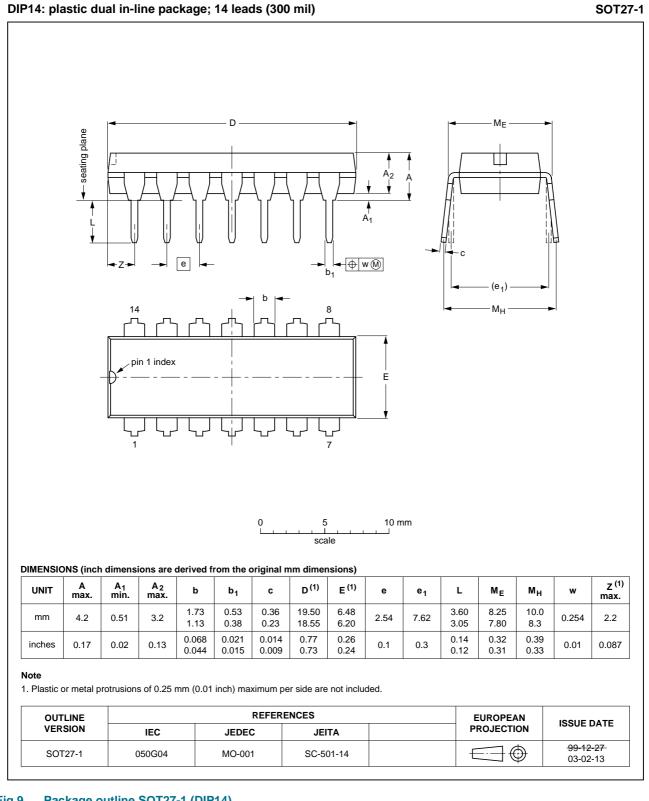
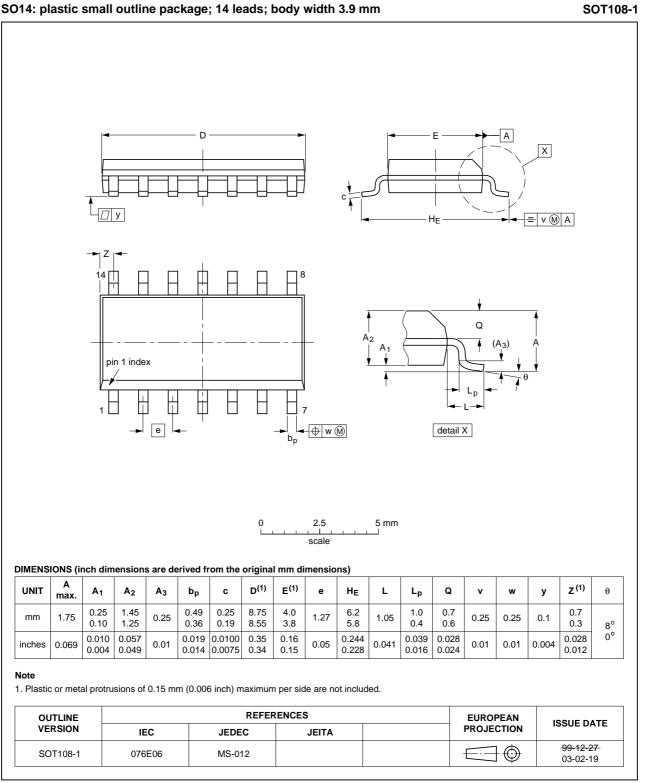


Fig 9. Package outline SOT27-1 (DIP14)

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

Fig 10. Package outline SOT108-1 (SO14)

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14. Abbreviations

ions
Description
Complementary Metal Oxide Semiconductor
Device Under Test
ElectroStatic Discharge
Human Body Model
Machine Model
Transistor-Transistor Logic

15. Revision history

Table 14. Revision h	nistory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4541B v.4	20120625	Product data sheet	-	HEF4541B_CNV v.3
Modifications:		of this data sheet has been r hiconductors.	edesigned to comply wit	h the new identity guidelines
	 Legal texts 	have been adapted to the ne	w company name where	e appropriate.
	 Section 2 "F 	eatures and benefits" added	l.	
HEF4541B_CNV v.3	19950101	Product specification	-	HEF4541B_CNV v.2
HEF4541B_CNV v.2	19950101	Product specification	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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